

Vishay Semiconductors

Small Signal Schottky Diodes

Features

- Integrated protection ring against static discharge
- · Low capacitance
- · Low leakage current
- Low forward voltage drop
- · Very low switching time
- · AEC-Q101 qualified
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



FREE



Applications

- General purpose and switching Schottky barrier diode
- HF-Detector
- · Protection circuit
- · Diode for low currents with a low supply voltage
- Small battery charger
- Power supplies
- DC/DC converter for notebooks

Mechanical Data

Case: MicroMELF
Weight: approx. 12 mg
Cathode band color: black
Packaging codes/options:

TR3/10 k per 13" reel (8 mm tape), 10 k/box TR/2.5 k per 7" reel (8 mm tape), 12.5 k/box

Parts Table

Part	Type differentiation	Ordering code	Remarks	
BAS381	V _R = 40 V	BAS381-TR3 or BAS381-TR	Tape and Reel	
BAS382	V _R = 50 V	BAS382-TR3 or BAS382-TR	Tape and Reel	
BAS383	V _R = 60 V	BAS383-TR3 or BAS383-TR	Tape and Reel	

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
		BAS381	V _R	40	V
Reverse voltage		BAS382	V _R	50	V
		BAS383	V _R	60	V
Peak forward surge current	t _p = 1 s		I _{FSM}	500	mA
Repetitive peak forward current			I _{FRM}	150	mA
Forward continuous current			I _F	30	mA

BAS381, BAS382, BAS383

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Thermal Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Junction to ambient air	on PC board 50 mm x 50 mm x 1.6 mm	R _{thJA}	320	K/W
Junction temperature		T _j	125	°C
Storage temperature range		T _{stg}	- 65 to + 150	°C

Electrical Characteristics

T_{amb} = 25 °C, unless otherwise specified

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Parameter	Test condition	Symbol	Min.	Typ.	Max.	Unit
Forward voltage	I _F = 0.1 mA	V _F			330	mV
	I _F = 1 mA	V_{F}			410	mV
	I _F = 15 mA	V _F			1000	mV
Reverse current	$V_R = V_{Rmax}$	I _R			200	nA
Diode capacitance	V _R = 1 V, f = 1 MHz	C _D			1.6	pF

Typical Characteristics

T_{amb} = 25 °C, unless otherwise specified

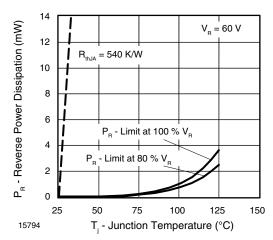


Figure 1. Max. Reverse Power Dissipation vs. Junction Temperature

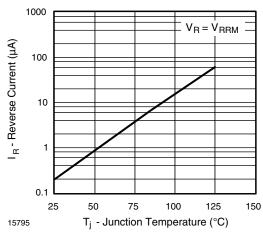


Figure 2. Reverse Current vs. Junction Temperature

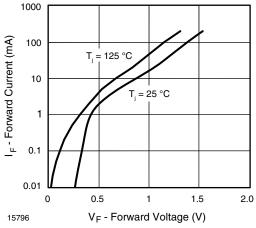


Figure 3. Forward Current vs. Forward Voltage

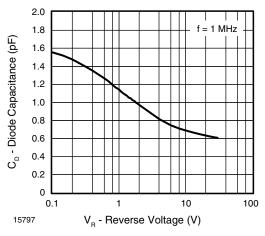


Figure 4. Diode Capacitance vs. Reverse Voltage



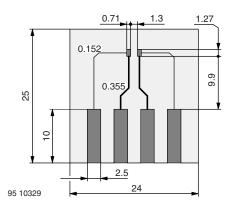
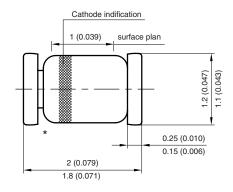
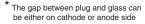
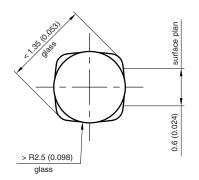


Figure 5. Board for R_{thJA} definition (in mm)

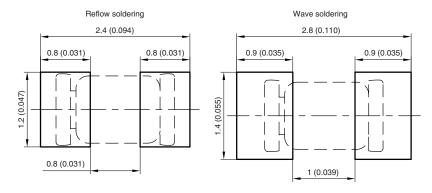
Package Dimensions in millimeters (inches): MicroMELF







Foot print recommendation:

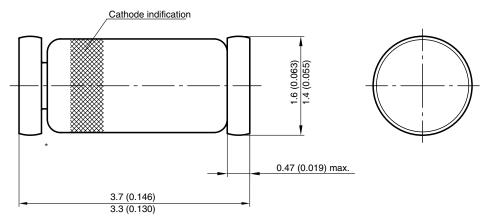


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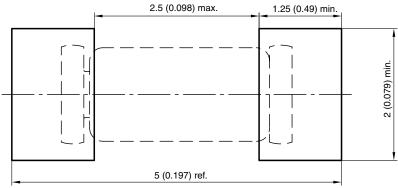
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PACKAGE DIMENSIONS in millimeters (inches)



* The gap between plug and glass can be either on cathode or anode side

Foot print recommendation:



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